

Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)  
 Contact Info: [ti.com/support](http://ti.com/support)  
 Form/Declaration Type: Distribute - RoHS and IEC 62474 DB  
 Created on: 05/09/2022

Details for "SN74LS155ADRG4"

**Current Product Information**

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package   Pins	Package body size (mm)	Total device mass (mg)*
SN74LS155ADRG4	NIPDAU	Level-1-260C-UNLIM	TI AGUASCALIENTES	D   16	3.91x9.9x1.58	238.5

\*Total Device Mass  
 The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

**Environmental Ratings Information**

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

**Component Information**

Component	Substance	CAS Number	Amount (mg)	Homogeneous Material Level		Component Level	
				Percentage %	ppm	Percentage %	ppm
<b>Bond Wire</b>							
Copper and Its Alloys	Copper	7440-50-8	0.089903	99.998888	999989	0.037695	377
Precious Metals	Silver	7440-22-4	0.000001	0.001112	11	0	0
Sub-Total			0.089904	100	1000000	0.037696	377
<b>Die Attach Adhesive</b>							
Precious Metals	Silver	7440-22-4	0.36591	79.000037	790000	0.153422	1534
Thermoplastics	Epoxy	85954-11-6	0.097267	20.999963	210000	0.040783	408
Sub-Total			0.463177	100	1000000	0.194204	1942
<b>Lead Frame</b>							
Copper and Its Alloys	Copper	7440-50-8	121.71875	97.375	973750	51.035168	510352
Copper and Its Alloys	Iron	7439-89-6	3.25	2.6	26000	1.362885	13627
Copper and Its Alloys	Phosphorus	7723-14-0	0.01875	0.015	150	0.007862	79
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.0125	0.01	100	0.005241	52
Sub-Total			125	100	1000000	52.410956	524110
<b>Lead Frame Plating</b>							
Nickel and Its Alloys	Nickel	7440-02-0	0.76096	95.12	951200	0.319061	3191
Precious Metals	Gold	7440-57-5	0.00624	0.78	7800	0.002616	26
Precious Metals	Palladium	7440-05-3	0.0328	4.1	41000	0.013753	138
Sub-Total			0.8	100	1000000	0.33543	3354
<b>Mold Compound</b>							
Other Inorganic Materials	Fused Silica	60676-86-0	97.206844	88	880000	40.757629	407576
Other Plastics and Rubber	Carbon Black	1333-86-4	0.331387	0.3	3000	0.138946	1389
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	0.607543	0.55	5500	0.254735	2547
Thermoplastics	Epoxy	85954-11-6	12.316549	11.15	111500	5.164177	51642
Sub-Total			110.462323	100	1000000	46.315487	463155
<b>Semiconductor Device</b>							
Ceramics / Glass	Doped Silicon	7440-21-3	1.684349	100	1000000	0.706227	7062
Sub-Total			1.684349	100	1000000	0.706227	7062
<b>Total</b>			238.499753			100	1000000

**Important Note**  
 The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.  
 The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.  
[See Glossary of Terms for more details.](#)

**Important Part Information**  
 There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMIS or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

**Product Content Methodology**  
[For an explanation of the methods used to determine material weights, See Product Content Methodology](#)

**Material Declaration Certificate for Semiconductor IC Packaged Products**

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

**Important Information/Disclaimer**

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."  
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Signature: [\(click here for a fuller statement with a signed certificate\)](#)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality  
 For further environmental statements, please go to [www.ti.com/ecoinfo](http://www.ti.com/ecoinfo)  
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**RoHS:** Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

**RoHS Exempt:** Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in <http://www.ti.com/lit/pdf/szzq088>

**Green:** Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide [Sb2O3] contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.